## **Declaration, Power of Attorney and Petition**

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WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled ABRASIVE PAD, METHOD AND METAL MOLD FOR MANUFACTURING THE SAME, AND SEMICONDUCTOR WAFER POLISHING METHOD the specification of which is attached hereto. was filed on Application Serial No. and amended on was filed as PCT international application Number \_\_\_\_\_ and was amended under PCT Article 19 on \_\_\_\_\_ (if applicable). We (I) hereby state that we (I) have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. We (I) acknowledge the duty to disclose information known to be material to the patentability of this application as defined in Section 1.56 of Title 37 Code of Federal Regulations. We (I) hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed. Prior Foreign Application(s) **Priority** Application No. Country Day/Month/Year Claimed No. 2003-105924 \_\_\_\_Japan 09/04/2003 Yes ☐ No ☐ Yes ☐ No

☐ No

☐ No

☐ Yes

We (I) hereby claim the benefit under Title 35, I application(s) listed below.	United States Code, § 1	19(e) of any United States provisional	
(Application Number)	(Filing	Date)	
(Application Number)	(Filing	Date)	
We (I) hereby claim the benefit under 35 U.S.C. any PCT International application designating the Uneach of the claims of this application is not disclosed the manner provided by the first paragraph of 35 U.S. is material to patentability as defined in 37 CFR § 1. application and the national or PCT International filing	nited States, listed below I in the prior United States. § 112, I acknowledge 56 which became availates.	w and, insofar as the subject matter of tes or PCT International application in the duty to disclose information which ble between the filing date of the prior	
Application Serial No. Filin	ng Date	Status (pending, patented, abandoned)	
And we (I) hereby appoint the following registered practitioner(s):			
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as our (my) attorneys, with full powers of substitution and revocation, to prosecute this application and to transact all business in the Patent Office connected therewith; and we (I) hereby request that all correspondence regarding this application be sent to			
	2850		
We (I) declare that all statements made herein of on information and belief are believed to be true; and that willful false statements and the like so made are p of Title 18 of the United States Code and that suc application or any patent issuing thereon.	d further that these state unishable by fine or imp	ements were made with the knowledge orisonment, or both, under Section 1001	
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NAME OF FIFTH JOINT INVENTOR	Residence:	
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•	Out of	
Signature of Inventor	Citizen of:	
-	Mailing Address:	